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Features

- 8 Independent Receivers (Rx)
- 3 Independent Transmitters (Tx)
- Full TS68K Family Microprocessor Interface Compatibility
- 16-bit Data-bus
- ARINC 429 Interface: "1" and "0" Lines, RZ Code
- Support all ARINC 429 Data Rate Transfer and up to 2.5 Mbit/s
- · Multi Label Capability
- Parity Control: Odd. Even. No Parity. Interrupt Capability
- Independent Programmable Frequency for Rx and Tx Channels
- 8 Messages FIFO per Tx Channel
- Independent Interrupt Request Line for Rx and Tx Functions
- Vectored Interrupts
- · Daisy Chain Capability
- · Direct Addressing of all Registers
- Test Modes Capability
- 20 MHz Operating Frequency
- Self-test Capability for Receiver Label Memories and Transmit FiFO
- Low Power: 400 mW

Description

The TS68C429A is an ARINC 429 controller. It is an enhanced version of the EF 4442 and it is designed to be connected to the new 16- or 32-bit microprocessors, especially these of the Atmel TS68K family.

Screening

- MIL-STD-883, class B
- DESC Drawing 5962-955180
- · Atmel Standards

Application Note

A detailed application note is available "AN 68C429A" on request.



R suffix

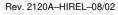


F suffix CQFP 132



CMOS
ARINC 429
Multichannel
Receiver/
Transmitter
(MRT)

TS68C429A







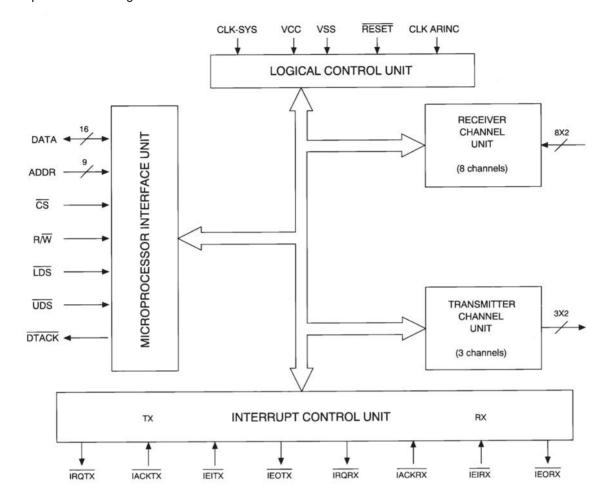
Hardware Overview

The TS68C429A is a high performance ARINC 429 controller designed to interface primary to the Atmel TS68K family microprocessor in a straight forward fashion (see "Application Notes" on page 33). It can be connected to any TS68K processor family with an asynchronous bus with some additional logic in some cases.

As shown in Figure 1, the TS68C429A is divided into five main blocks, the microprocessor interface unit (MIU), the logical control unit (LCU), the interrupt control unit (ICU), the receiver channel unit (RCU) and the transmitter channel unit (TCU).

- The MIU handles the interface protocol of the host processor. Through this unit, the host sees the TS68C429A as a set of registers.
- The LCU controls the internal data flow and initializes the TS68C429A.
- The ICU manages one interrupt line for the RCU and one for the TCU. Each of these two parts has a daisy chain capability. All channels have a dedicated vectored interrupt answer. Receiver channels priority is programmable.
- The RCU is composed of 8 ARINC receiver channels made of:
 - a serial to parallel converter to translate the two serial signals (the "1" and "0" in RZ code) into two 16-bit words,
 - a memory to store the valid labels,
 - a control logic to check the validity of the received message,
 - a buffer to keep the last valid received message.
- The TCU is composed of three ARINC transmitter channels made of:
 - a parallel to serial converter to translate the messages into two serial signals (the "1" and "0" in RZ code),
 - a FIFO memory to store eight 32-bit ARINC messages,
 - a control logic to synchronize the message transmitter (parity, gap, speed, etc.).
- Test facility: Rx inputs can be internally connected to TX3 output.
- Self-test facility: The receiver control label matrix and transmitter FIFO can be tested. This self-test can be used to verify the integrity of the TS68C429A memories.

Figure 1. Simplified Block Diagram





Package

See "Package Mechanical Data" on page 40 and "Terminal Connections" on page 41.

Figure 1. Signal Description

Pin Name	Туре	Function
A0-8	I	Address bus. The address bus is used to select one of the internal registers during a processor read or write cycle.
D0-15	I/O	This bi-directional bus is used to receive data from or transmit data to an internal register during a processor read or write cycle. During an interrupt acknowledge cycle, the vector number is given on the lower data bus (D0 - D7).
CS	I	Chip select (active low). This input is used to select the chip for internal register access.
LDS	I	Lower data strobe. This input (active low) validates lower data during R/\overline{W} access (D0-D7).
UDS	I	Upper data strobe. This input (active low) validates upper data during R/\overline{W} access (D8-D15).
R/\overline{W}	I	Read/write. This input defines a data transfer as a read (high) or a write (low) cycle.
DTACK	0	Data transfer acknowledge. If the bus cycle is a processor read, the chip asserts $\overline{\text{DTACK}}$ to indicate that the information on the data bus is valid. If the bus cycle is a processor write, $\overline{\text{DTACK}}$ acknowledges the acceptance of the data by the MRT. $\overline{\text{DTACK}}$ will be asserted during chip select access ($\overline{\text{CS}}$ asserted) or interrupt acknowledge cycle ($\overline{\text{IACKTX}}$ or $\overline{\text{IACKRK}}$ asserted).
ĪRQTX	0	Interrupt transmit request. This open drain output signals to the processor that an interrupt is pending from the transmission part of the MRT. There are 6 causes that can generate an interrupt request (2 per channel: FIFO empty and end of transmission).
IACKTX	I	Interrupt transmit acknowledge. If $\overline{\text{IRQTX}}$ is active, the MRT will begin an interrupt acknowledge cycle. The MRT will generate a vector number to the processor which is the highest priority channel requesting interrupt service.
ĪEITX	I	Interrupt transmit enable in. This input, together with IEOTX signal, provides a daisy chained interrupt structure for a vectored scheme. IEITX (active low) indicates that no higher priority device is requesting interrupt service.
ĪEOTX	0	Interrupt transmit enable out. This output, together with IEITX signal, provides a daisy chained interrupt structure for a vectored interrupt scheme. IEOTX (active low) indicates to lower priority devices that neither the TS68C429A nor any highest priority peripheral is requesting an interrupt.
ĪRQRX	0	Interrupt transmit request. This open drain output signals to the processor that an interrupt is pending from the receiving part of the chip. There are 9 causes that can generate an interrupt request (1 per channel: valid message received, and 1 for bad parity on a received message).
IACKRX	I	Interrupt receive acknowledge. Same function as IACKTX but for receiver part.
ĪEIRX	I	Interrupt receive enable in. Same function as IEITX but for receiver part.
ĪEORX	I	Interrupt receive enable out. Same function as IEOTX but for receiver part.
TX1H	0	Transmission "1" line of the channel 1.
TX1L	0	Transmission "0" line of the channel 1.
TX2H	0	Transmission "1" line of the channel 2.
TX2L	0	Transmission "0" line of the channel 2.
ТХЗН	0	Transmission "1" line of the channel 3.
TX3L	0	Transmission "0" line of the channel 3.
RX1H	I	Receiving "1" line of the channel 1.
RX1L	I	Receiving "0" line of the channel 1.
RX2H	I	Receiving "1" line of the channel 2

Figure 1. Signal Description (Continued)

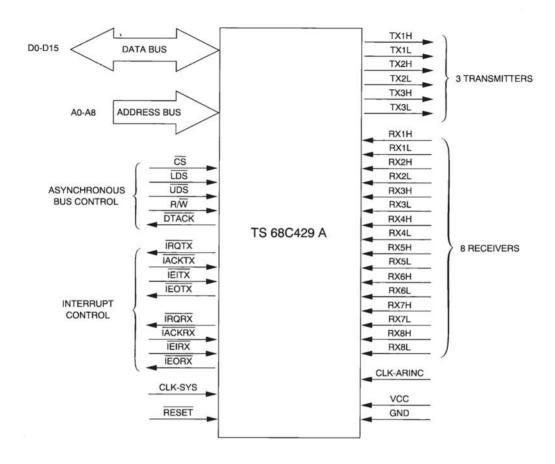
Pin Name	Туре	Function
RX2L	I	Receiving "0" line of the channel 2.
RX3H	I	Receiving "1" line of the channel 3.
RX3L	I	Receiving "0" line of the channel 3.
RX4H	I	Receiving "1" line of the channel 4.
RX4L	I	Receiving "0" line of the channel 4.
RX5H	I	Receiving "1" line of the channel 5.
RX5L	I	Receiving "0" line of the channel 5.
RX6H	I	Receiving "1" line of the channel 6.
RX6L	I	Receiving "0" line of the channel 6.
RX7H	I	Receiving "1" line of the channel 7.
RX7L	I	Receiving "0" line of the channel 7.
RX8H	I	Receiving "1" line of the channel 8.
RX8L	I	Receiving "0" line of the channel 8.
RESET	I	This input (active low) will initialize the TS68C429A registers.
V _{CC} /GND	I	These inputs supply power to the chip. The $V_{\rm CC}$ is powered at +5 volts and GND is the ground connection.
CLK-SYS	I	The clock input is a single-phase signal used for internal timing of processor interface.
CLK-ARINC	I	This input provides the timing clock to synchronize received/transmitted messaged.





Figure 2 illustrates the functional signal groups.

Figure 2. Functional Signal Groups Diagram



Scope

This drawing describes the specified requirements for the ARINC multi channel receiver/transmitter, in compliance either with MIL-STD-863 class B or SMD drawing.

Applicable Documents

MIL-STD-883

- 1. MIL-STD-883: test methods and procedures for electronics
- 2. MIL-STD-38535: general specifications for microcircuits.
- 3. MIL-STD-1835 microcircuit case outlines.
- 4. DESC/SMD.

Requirements

General

The microcircuits are in accordance with the applicable document and as specified herein.

Design and Construction

Terminal Connections

Depending on the package, the terminal connections is detailed in "Terminal Connections" on page 41.

Package

The circuits are packaged in a hermetically sealed ceramic package which is conform to case outlines of MIL-STD 1835 (when defined):

- PGA 84.
- CQFP 132.

The precise case outlines are described at the end of this specification ("Package Mechanical Data" on page 40) and into MIL-STD-1835.

Special Recommended Conditions for CMOS Devices

· CMOS Latch-up

The CMOS cell is basically composed of two complementary transistors (a P-channel and an N-channel), and, in the steady state, only one transistor is turned-on. The active P-channel transistor sources current when the output is a logic high and presents a high impedance when the output is a logic low. Thus the overall result is extremely low power consumption because there is no power loss through the active P-channel transistor. Also since only once transistor is determined by leakage currents.

Because the basic CMOS cell is composed of two complementary transistors, a parasitic semiconductor controlled rectifier (SCR) formed and may be triggered when an input exceeds the supply voltage. The SCR that is formed by this high input causes the device to become "latched" in a mode that may result in excessive current drain and eventual destruction of the device. Although the device is implemented with input protection diodes, care should be exercised to ensure that the maximum input voltages specification is not exceeded from voltage transients; others may require no additional circuitry.

· CMOS/TTL Levels

The TS68C429A doesn't satisfy totally the input/output drive requirements of TTL logic devices, see Table 4.

Electrical Characteristics

Table 1. Absolute Maximum Ratings

Symbol	Parameter	Test Conditions	Min	Max	Unit
V _{CC}	Supply Voltage		-0.3	+7.0	V
V _I	Input Voltage		-0.3	+7.0	V
P _{dmax}	Max Power Dissipation			400	mW
т.	Operating Temperature	M suffix	-55	+125	°C
T _{case}	Operating Temperature	V suffix	-40	+85	°C
T _{stg}	Storage Temperature		-55	+150	°C
T _j	Junction Temperature			+160	°C
T _{leads}	Lead Temperature	Max 5 sec. soldering		+270	°C





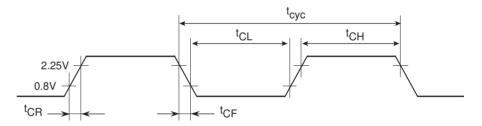
Unless otherwise stated, all voltages are referenced to the reference terminal.

Table 2. Recommended Condition of Use

Symbol	Parameter	Test conditions	Min	Max	Units
V_{CC}	Supply Voltage		4.5	5.5	V
V _{IL}	Low Level Input Voltage		-0.5	0.8	V
V _{IH}	High Level Input Voltage		2.25	5.8	V
т.	OtiTt	M suffix	-55	+125	°C
T_{case}	Operating Temperature	V suffix	-40	+85	°C
C_L	Output Loading Capacitance			130	pF
t _r (c)	Clock Rise Time (See Figure 3)			5	ns
t _f (c)	Clock Fall Time (See Figure 3)			5	ns
f _c	Clock System Frequency (See Figure 3)		0.5	20	MHz

This device contains protective circuitry against damage due to high static voltages or electrical fields: however, it is advised that normal precautions be taken to avoid application of any voltages higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either GND or VCC).

Figure 3. Clock Input Timing Diagram



Note: Timing measurements are referenced to and from a low of 0.8-volt and a high voltage of 2.25 volts, unless otherwise noted. The voltage swing through this range should start outside and pass through the range such that the rise or fall will be linear between 0.8-volt and 2.25 volts.

Table 3. Thermal Characteristics

Package	Symbol	Parameter	Value	Unit
DCA 60	θ_{J-A}	Thermal Resistance Junction-to-ambient	28	°C/W
PGA 68 θ _{J-C}		Thermal Resistance Junction-to-case	2	°C/W
COED 100	θ_{J-A}	Thermal Resistance Junction-to-ambient	27	°C/W
CQFP 132	$\theta_{ extsf{J-C}}$	Thermal Resistance Junction-to-case	3	°C/W

Power Considerations

The average chip-junction temperature, T_{.I}, in °C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \cdot \theta_{JA}) \tag{1}$$

T_A = Ambient Temperature, °C

θ_{JA} = Package Thermal Resistance, Junction-to-Ambient, °C/W

$$P_D = P_{INT} + P_{I/O}$$

P_{INT} = I_{CC} x V_{CC}, Watts—Chip Internal Power

P_{I/O} = Power Dissipation on Input and Output Pins—User Determined

For most applications $P_{I/O} < P_{INT}$ and can be neglected.

An approximate relationship between P_D and T_A (if $P_{I/O}$ is neglected) is:

$$P_D = K: (T_1 + 273)$$
 (2)

Solving equations (1) and (2) for K gives:

$$K = P_{D} \cdot (T_{A} + 273) + \theta_{JA} \cdot P_{D}^{2}$$
 (3)

where K is a constant pertaining to the particular part K can be determined from equation (3) by measuring P_D (at equilibrium) for a known T_A . Using this value of K, the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

The total thermal resistance of a package (θ_{JA}) can be separated into two components, θ_{JC} and θ_{CA} , representing the barrier to heat flow from the semiconductor junction to the package (case), surface (θ_{JC}) and from the case to the outside ambient (θ_{CA}) . These terms are related by the equation:

$$\theta_{\mathsf{JA}} = \theta_{\mathsf{JC}} + \theta_{\mathsf{CA}} \tag{4}$$

 θ_{JC} is device related and cannot be influenced by the user. However, θ_{CA} is user dependent and can be minimized by such thermal management techniques as heat sinks, ambient air cooling and thermal convection. Thus, good thermal management on the part of the user can significantly reduce θ_{CA} so that θ_{JA} approximately equals θ_{JC} . Substitution of θ_{JC} for θ_{JA} in equation (1) will result in a lower semiconductor junction temperature.

Mechanical and Environment

The microcircuits shall meet all mechanical environmental requirements of either MIL-STD-883 for class B devices or DESC devices.

Marking

The document where are defined the marking are identified in the related reference documents. Each microcircuit are legibly and permanently marked with the following information as minimum:

- Atmel logo
- Manufacturer's part number
- · Class B identification
- · Date-code of inspection lot
- ESD identifier if available
- Country of manufacturing





Quality Conformance Inspection

DESC/MIL-STD-883

Is in accordance with MIL-M-38510 and method 5005 of MIL-STD-883. Group A and B inspections are performed on each production lot. Group C and D inspections are performed on a periodic basis.

Electrical Characteristics

General Requirements

All static and dynamic electrical characteristics specified for inspection purposes and the relevant measurement conditions are given below:

- Table 4. Table 5: Static electrical characteristics for the electrical variants.
- Table 6, Table 7, Table 8: Dynamic electrical characteristics.

For static characteristics (Table 4, Table 5), test methods refer to IEC 748-2 method number, where existing.

For dynamic characteristics (Table 6, Table 7, Table 8), test methods refer to clause 5.5 of this specification.

Table 4. DC Electrical Characteristics

With -55°C $\leq T_{case} \leq +125$ °C or -40° $\leq T_{case} \leq +85$ °C; V_{CC} = 5V \pm 10%.

Symbol	Parameter	Parameter			Unit
V _{IH}	Input High Voltage		2.25	V _{CC} + 0.3	V
V_{IL}	Input Low Voltage		-0.5	0.8	V
V _{OH}	Output High Voltage (except IRQRX, IRQT	X: open drain outputs)	2.7		V
V _{OL}	Output Low Voltage		0.5	V	
I _{OH}	Output Source Current (except IRQRX, IRQTX: open drain outputs)	(V _{out} = 2.7V)		-8	mA
I _{OL}	Output Sink Current (V _{out} = 0.5V)			8	mA
I _{LI}	Input Leakage Current (V _{in} = 0 to V _C			±20	μΑ
IDD	Dynamic Current ⁽¹⁾	$(T_{case} = T_{min} \cdot V_{DD}$ = V_{max})		65	mA

Note: 1. IDD is measured with all I/O pins at 0V, all input pins at 0V except signals CS, IACKxx, LDS, UDS at 5V and CLK-SYS and CLK-ARINC which run at t_{cvc} mini.

Table 5. Capacitance $(T_A = 25^{\circ}C)$

Symbol	Parameter	Max	Unit
C _{in}	Input Capacitance	10	pF
C _{out}	HI-Z Output Capacitance	20	pF

Clock Timing

Table 6. Clock System (CLK SYS)

Symbol	Parameter	Min	Max	Unit
t _{cyc} S	Clock Period	50	2000	ns
t _{CLS} , t _{CHS}	Clock Pulse Width	20		ns
t _{crS} , t _{cfS}	Rise and Fall Times		5	ns

Table 7. Clock ARINC (CLK ARINC)

Symbol	Parameter	Min	Max	Unit
t _{cyc} A	Cycle Time ⁽¹⁾	200	8000	ns
t _{CLA} , t _{CHA}	Clock Pulse Width	240		ns
t _{crA} , t _{cfA}	Rise and Fall Times		5	ns

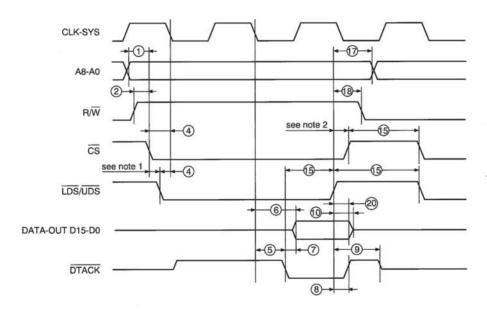
Note: 1. $t_{cyc} A \ge 4 \times t_{cyc} S$.

AC Electrical Characteristics

With $V_{CC} = 5 V_{DC} \pm 10\% V_{SS} = 0 V_{DC}$.

IEIxx, IEOxx, IACKxx, must be understood as generic signals (xx = RX and TX).

Figure 4. Read Cycle

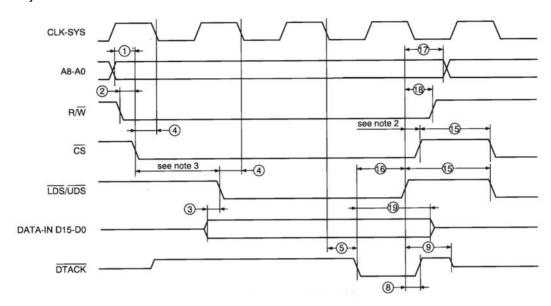


Notes: 1. LDS/UDS can be asserted on the next or previous CLK-SYS period after CS goes low but (4) must be met for the next period.

2. The cycle ends when the first of \overline{CS} , $\overline{LDS}/\overline{UDS}$ goes high.

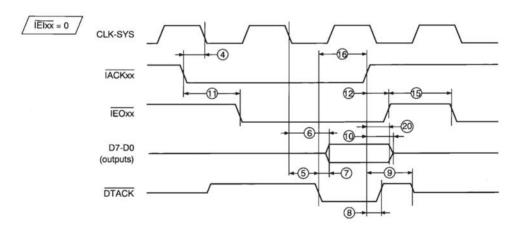


Figure 5. Write Cycle



3. LDS/UDS can be asserted on the same or previous CLK-SYS period as CS but (3) and (4) must be met.

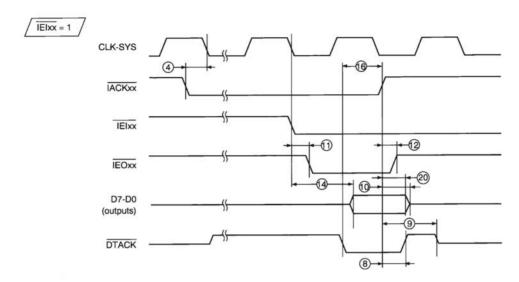
Figure 6. Interrupt Cycle (IEIxx = 0)



Notes: 1. If $\overline{\text{UDS}} = 1$, D15-D8 stay hi-z else D15-D8 drive the bus with a stable unknown value.

2. If IEOxx goes low, neither vector nor DTACK are generated, else IEOxx stays inactive and a vector is generated (D7-D0 and DTACK).

Figure 7. Interrupt Cycle (IEIxx = 1)



Notes: 1. If $\overline{\text{UDS}} = 1$, D15-D8 stay hi-z else D15-D8 drive the bus with a stable unknown value.

2. If IEOxx goes low, neither vector nor DTACK are generated, else IEOxx stays inactive and a vector is generated (D7-D0 and DTACK).

Table 8. Timing Characteristic

Number	Symbol	Parameter	Min	Max	T / G ⁽¹⁾	Unit
1	t _{AVCSL}	Address valid to CS low	0	-	Т	ns
2	t _{RWVCSL}	R/W valid to CS low	0	-	Т	ns
3	t _{DIVDSL}	Data in valid to LDS/UDS low	0	-	Т	ns
4	t _{SVCL}	CS, LDS/UDS, IACKxx valid to CLK-SYS low	5	-	Т	ns
5	t _{CLDKL}	CLK-SYS low to DTACK low	-	45	Т	ns
6	t _{CLDOV}	CLK-SYS low to data out valid	-	50	Т	ns
7	t _{DKLDOV}	DTACK low to data out valid	-	10	G	ns
8	t _{SHDKH}	CS or LDS/UDS or IACKxx high to DTACK high	-	35	G	ns
9	t _{SHDXZ}	CS or LDS/UDS or IACKxx high to DTACK hi-z	-	50	G	ns
10	t _{SHDOZ}	CS or LDS/UDS or IACKxx high to data out hi-z	-	25	G	ns
11	t _{ILIOL}	IEIxx or IACKxx low to IEOxx low	-	35	Т	ns
12	t _{IKHIOH}	IACKxx high to IEOxx high	-	40	Т	ns
13	t _{IILDKL}	IEIxx low to DTACK low	-	40	Т	ns
14	t _{IILDOV}	IEIxx low to data out valid	-	45	Т	ns
15	t _{SH}	CS, IACKxx, LDS/UDS inactive time	15	-	Т	ns
16	t _{DKLSH}	DTACK low to CS or LDS/UDS or IACKxx high	0	-	G	ns
17	t _{SHAH}	CS or LDS/UDS high to address hold time	0		G	ns





Table 8. Timing Characteristic (Continued)

Number	Symbol	nbol Parameter		Max	T/G ⁽¹⁾	Unit
18	t _{SHRWI}	CS or LDS/UDS high to R/W invalid	0	-	G	ns
19	t _{DKLDIH}	DTACK low to data in hold time	0	-	G	ns
20	t _{shdoh}	CS or LDS/UDS or IACKxx high data out hold time	0	-	G	ns

Note: 1. T/G = Tested/Guaranteed.

Functional Description

Receiver Channel Unit (RCU)

Overview

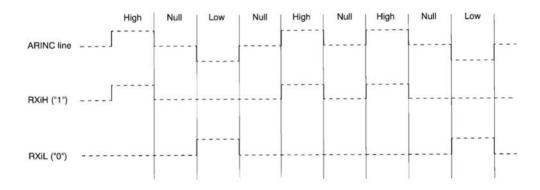
The RCU is composed of 8 ARINC receiver channels and has per channel:

- a serial to parallel converter to translate the two serial signals in two 16-bit words.
- a memory to store the authorized labels,
- a control logic to check the validity of the received message.
- a buffer to keep the last valid received message.

Inputs

Each receiver channel has two input lines, receiving line high (RxiH) and receiving line low (RXiL) which are not directly compatible with the bipolar modulated ARINC line. This ARINC three-level state signals ("HIGH", "NULL", "LOW") should be demultiplexed to generate the two RZ lines according to Figure 8.

Figure 8.



Description

Each channel has a test mode in which the input signals (RXiH, RXiL), are internally connected to the third Transmit Channel Lines. This selection is done by programming the Test bit in the receiver control register (see "Register Description" on page 17) except this difference, the TS68C429A behaves exactly the same manner in the two modes. The receiver channel block diagram is given in Figure 9.

ARINC signals being asynchronous, the RCU first rebuilds the received clock in order to transfer the data within the shift-register and when the Gap-controller has detected the end of the message, tests the message validity according to the criteria listed hereafter.

To detect the end of the message, the Gap-Controller waits for a Gap after the last received bit. To do so, at each CLK ARINC cycle, a counter is incremented and compared to the content of the Gap-Register which has the user programmed value. If both values are equal, the counter is stopped and an internal end of message signal is generated. This counter is reseted on the falling edge of the rebuilt clock. Figure 9 shows the gap detection principle.

When the end of message is detected, the TS68C429A verifies the following points:

- the number of received bits must be 32.
- if requested the message parity (see "Register Description" on page 17) is compared to the parity bit of the message,
- the message label must be equal to one of the label stored in the Label Control Matrix.
- the Buffer is empty (that is: the last message has been read). The corresponding bit in the Status-register (see logical interface unit), has been cleared,
- when all four conditions are met, the message is transferred from the Shift-register
 to the Buffer and the corresponding bit is set in the Status-register. If the interrupt
 mode is enabled (see "General Circuit Control" on page 24) the IRQRX line is
 activated.

If not, reception of a new message is enabled, see Note.

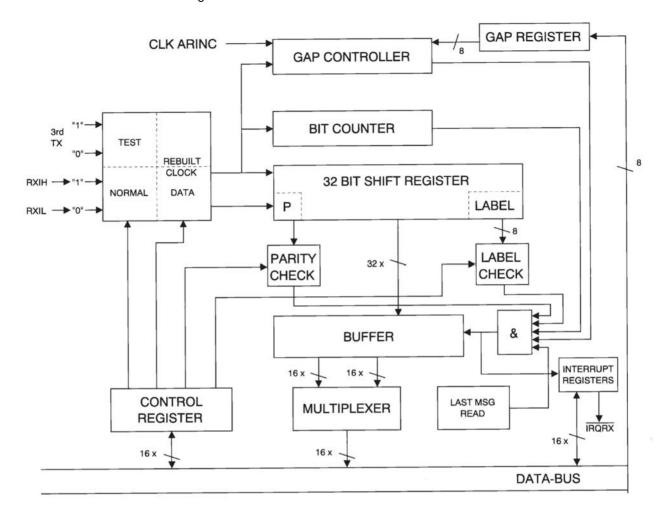
If only the message parity is incorrect, an interrupt can be generated (see "Register Description" on page 17).

The Buffer is seen as two 16-bit word registers, the Most Significant Word of the message (MSW) is contained in the lower address, the Less Significant Word of the message (LSW) is contained in the upper address. The MSW should be read first because reading the LSW will release the buffer and allow transfer of a new message from the Shift-register.



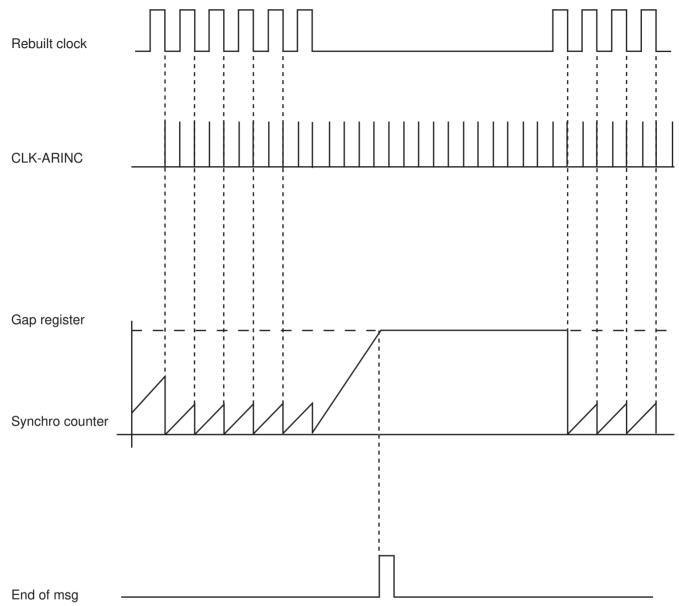


Figure 9. Receiver Channel Block Diagram



Note: A valid message is stored in the Shift-Reg. until a new message arrives and so may be transferred to the message buffer as soon as the buffer is "freed".





Register Description

Four registers are associated to each receiver channel. These four registers are:

- a) receiver control
- b) gap register
- c) message buffer
- d) label control matrix

• Register Control Register

This read/write register controls the function of the related receiver channel:





The lowest value will give the highest priority. If two channels have the same priority, one of them will never be able to send its interrupt vector to the microprocessor. Each channel must have a unique channel priority order.

Figure 11.

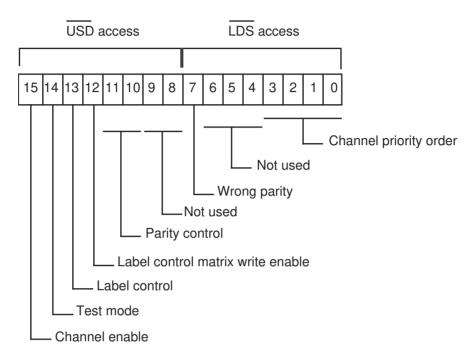


Table 9. Register Control Register Description

Bit	Function	Comments
Bit 15	Channel enable	0: channel is out of service 1: channel is in service
Bit 14	Test mode	0: external ARINC lines as input (normal operation) 1: third transmitter lines as input (test mode)
Bit 13	Label control	0: no control, all the labels are accepted 1: automatic check of the label according to the label control matrix
Bit 12	LCMWE label control matrix write enable	0: receiving mode (write to the matrix are disabled) 1: programmation mode for labels control matrix
Bit 11	Parity control	0: even parity check 1: odd parity check
Bit 10	Parity control	0: parity check is disable 1: parity check is enable
Bit 9	Not used	
Bit 8	Not used	
Bit 7	Wrong parity: this feature is enabled only if the self-test register bit 0 is set 1	0: received message parity is correct if read, reset wrong wrong parity flag if written. 1: an incorrect received message parity has been detected (the corresponding message is lost) (set by hardware).
Bit 6	Not used	

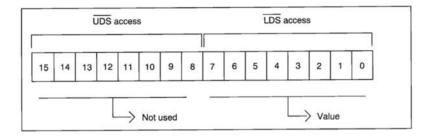
Table 9. Register Control Register Description

Bit	Function	Comments
Bit 5	Not used	
Bit 4	Not used	
Bit 0 to 3	Channel priority: order	The lowest value will give the highest priority. Each channel must have a unique channel priority order.
		If several messages are pending, the interrupt vector will account for highest priority channel.

• Gap Register (Figure 12)

The gap register is accessible for writing operations only. It contains the value on which the gap counter will be stopped and will generate the end of the message signal (see "Inputs" on page 14). The value is interpreted as a multiple of the CLK ARINC period.

Figure 12. Gap Register Description



The value of the gap register must be chosen so as to generate the end of the message before the minimal gap as defined in the ARINC-429 norm.

Message Buffer

The Buffer is made of two 16-bit registers, the Most Significant Word of the message (MSW) is contained in the lower address register, the Least Significant Word of the message (LSW) is contained in the upper address register. For correct behavior, the MSW must be read before the LSW. They are accessible in read mode only and 16-bit access is mandatory.

· Label Control Matrix

The label control matrix is a 256 x 1 bit memory. There is one memory per channel.

The address is driven by the incoming label, the output data is used to validate this incoming message label (see Figure 13). To program this matrix, the LCMWE (label control matrix write enable) bit of the receiver-control-register should be set to "1" to allow the access. At this time, the address is driven by the external address bus and the data are written from the data bus D7 to D0 (one per channel according to Figure 14). Any write to a matrix on which the LCMWE is not set will not have any effect. The label control matrix can be written or read in byte and word mode. In word mode, the state of D15-D8 is unknown. After complete programming of the matrix, the LCMWE bit should be reset to "0" to allow normal receiving mode. A "1" in the memory means that this label is allowed and a "0" means that this label must be ignored.





Figure 13. Label Control Matrix

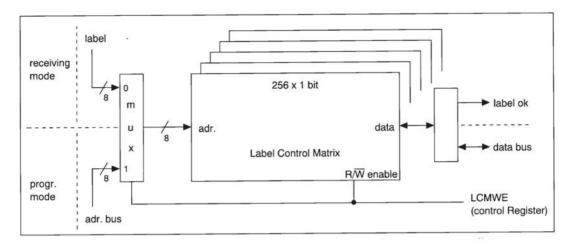
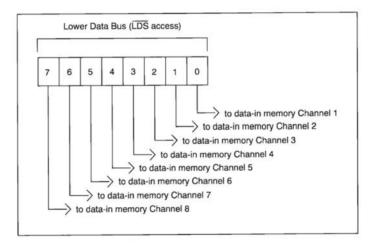


Figure 14.



Transmitter Channel Unit (TCU)

Overview

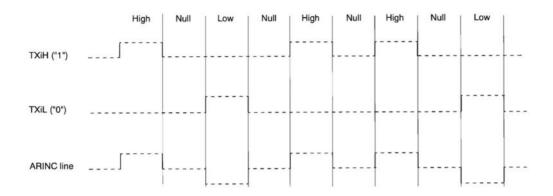
The TCU is composed of three ARINC transmit channels and has per channel:

- a parallel to serial converter to translate the messages into two serial signals,
- · a FIFO memory to store eight 32-bit ARINC messages,
- a control logic to synchronize the message transmitter (parity, gap, speed...).

Outputs

Each transmitter channel has two output lines, Transmit line High (TXiH) and Transmit line Low (TXiL) which are not directly compatible with the bipolar modulated ARINC line. These RZ format lines should be translated by an outside device into ARINC three-level state signal according to Figure 15.

Figure 15. Transmitter Channel Unit Outputs



Description

The block diagram of a transmit channel is given in Figure 16. Only the third channel can be switched to internal lines for test mode, otherwise the channels are identical. The selection of this test mode is done by programming the test bit in the transmitter-control-register (see "Register Description" on page 17). In this test mode the lines TX3H and TX3L are not driven, they are both kept at "0".

The transmit frequency is generated by dividing the ARINC clock signal (CLK ARINC) by the value contained in the frequency register. This divided clock synchronizes the shift register which sends the 32-bit word on the lines TXiH and TXiL.

The parity is computed and if requested (see "Register Description" on page 17) the parity bit (32nd bit of the message) is modified to have an odd number of "1" in the 32-bit message for odd parity or an even number of "1" in the 32-bit message for even parity.

A gap control block generates a gap between the sent messages. The value of this gap is defined by the 5 bits "transmission gap" of the transmitter-control-register, it is given in number of ARINC bit (see "Register Description" on page 17).

A FIFO control block manages the messages to be sent. Up to 8 messages can be written into the FIFO. The FIFO is seen as a two 16-bit memory words, the Most Significant Word of the message (MSW) is written in the lower address, the Least Significant Word of the message (LSW) is written in the upper address. The MSW should be written first. The access to the FIFO is 16 bits mandatory. The number of messages within the FIFO is indicated by a counter that can be read through the transmitter-control-register. This counter is incremented when the LSW is written and decremented when the message is transferred to the shift-register. The "Reset FIFO" bit is used to cancel messages within the FIFO. If a transmission is on going, the entire message will be sent. The "reset FIFO" bit remains active until written at 1 by the microprocessor. When the transmitter is disable during a transmission, the out going message is lost.

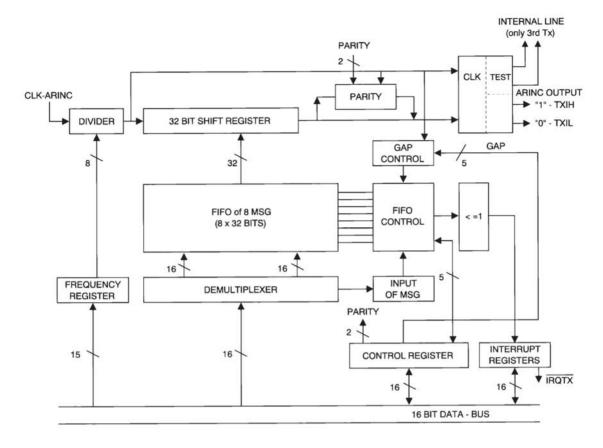
When the FIFO is empty, a bit is set in the status-register (see "General Circuit Control" on page 24). If the interrupt mode is enabled (see "General Circuit Control" on page 24) the IRQTX line is activated.

When the transmitter FIFO is empty and when no transmission is on going, the first write access to the FIFO has to be preceded by the following sequence: disable and enable transmission (see Figure 36: First FIFO access).





Figure 16. Transmitter Channel Block Diagram



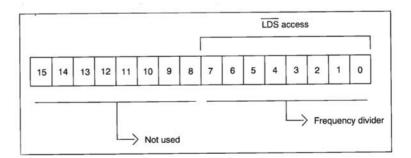
Register Description

Three registers are associated to each transmitter channel:

- · the frequency register,
- the transmitter control register,
- · the FIFO.
- The Frequency Register

The frequency register is only accessible for writing operations by the user and contains the frequency divider.

Figure 17. Frequency Register



The transmission frequency can be computed by dividing the CLK ARINC frequency by the frequency register value.

The frequency register must be loaded with a value greater or equal to 2.

• The Transmitter Control Register

The transmitter control register is accessible for reading and writing operations.

Figure 18. Transmitter Control Register

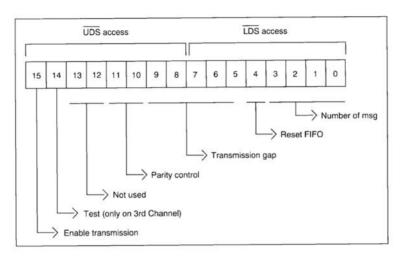


Table 10. Transmission Control Register Description

Bit	Function	Comments	
Bit 15	Enable transmission	 0: channel out of service (stops on going transmission) 1: channel in service 1 to 0: transition is not allowed at the same time as an 1 to 0 transition of the bit 4 when the transmitter FIFO is empty and when no transmission is on going, the first write access to the FIFO has to be preceded by the following sequence: reset to 0 and then set to 1 	
Bit 14	Test (only 3rd channel)	0: normal operating 1: test, output are only driven on internal lines for input testing	
Bit 13 to 12	Not used		
Bus 11	Parity control	0: even parity calculation 1: odd parity calculation	
Bit 10	Parity control	0: parity disable, Bit 32 of the message stays unchanged 1: parity enable. Bit 32 of the message will be forced by parity control	
Bit 9 to 5	Transmission gap	"transmission gap" which is the delay between two 32-bit ARINC messages (in ARINC bit)	
Bit 4	Reset FIFO	 - write a 0 in this bit reset the FIFO counter - this bit must be set to 1 before any write in the transmit buffer. - 1 to 0: transition is not allowed at the same time as an 1 to 0 transition of the bit 15 	
Bit 3 to 0	Number of msg	these four bits indicate the available space within the FIFO	





FIFO

The FIFO is seen as two 16-bit words. The Most Significant Word (MSW) must be written first. The Least Significant Word (LSW) write increments the FIFO counter.

Before any write, the user should verify that the FIFO is not full. If the FIFO is full, any write to the FIFO will be lost.

General Circuit Control

Logical Control Unit (LCU)

The LCU mainly distributes the clocks and reset within the MRT. The reset signal, active low is an asynchronous signal. When it occurs, all registers are reset to zero except the Label-Control-Matrix which is not initialized and the Status-Register which is set to FC00 (hex). Reset duration must be greater than 4 clk-cyc periods.

The LCU contains the Status-register. This read/write register indicates the state of the internal operations. It is also the image of the pending interrupts if they are not masked. Clearing a bit "RX-Channel-i" will cancel the received message and release the Message-buffer for reception of a new message. The "End of TX on channel-i" Is set only when the involved channel FIFO is empty. The format of the Status-Register is given below.

Figure 19. Status Register

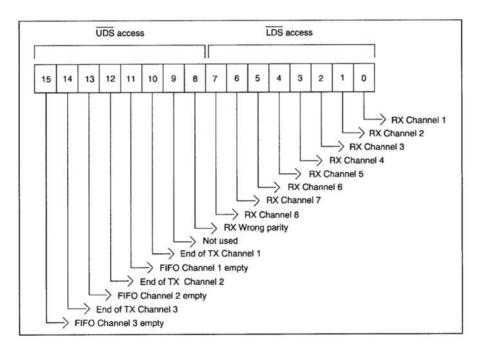


Table 11. Description of LCU Status Register

Bit	Function	Comments
Bit 15, 13, 11	FIFO channel 3, 2, 1 empty	0: FIFO not empty 1: FIFO empty
Bit 14, 12, 10	End of transmission on channel 3, 2,	Transmission occurs No transmission actually
Bit 8	RX wrong parity. This feature is available only if self-test register bit 0 is set to 1. This bit must be reset to 0 by user when needed.	No wrong parity received tleast one receiver has received a message with wrong parity (set by hardware).
Bit 7, 6, 5, 4, 3, 2, 1, 0	Receiving channel 8, 7, 6, 5, 4, 3, 2, 1	Waiting for message Received correct message

Microprocessor Interface Unit (MIU)

This interface which is directly compatible with the Atmel TS68K family is based on an asynchronous data transfer.

The data exchange is mandatory on 16 bits for access to the FIFO messages (transmitter) and to the message buffer (receiver). For other access it can be on byte on D0-D7 with LDS assertion or an D8-D15 with UDS assertion.

Figure 20 and Figure 21 show the read and write flow chart.

Figure 20. Read Cycle Flow Chart

